

# **MOSFET** - SiC Power, Single N-Channel, TO247-4L 650 V, 19 mΩ, 99 A

## NVH4L025N065SC1

#### **Features**

- Typ.  $R_{DS(on)} = 19 \text{ m}\Omega$  @  $V_{GS} = 18 \text{ V}$ Typ.  $R_{DS(on)} = 25 \text{ m}\Omega$  @  $V_{GS} = 15 \text{ V}$
- Ultra Low Gate Charge (Q<sub>G(tot)</sub> = 164 nC)
- Low Capacitance (C<sub>oss</sub> = 278 pF)
- 100% Avalanche Tested
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb-Free and is RoHS Compliant

#### **Typical Applications**

- Automotive On Board Charger
- Automotive DC/DC Converter for EV/HEV

#### **MAXIMUM RATINGS** (T<sub>J</sub> = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			$V_{DSS}$	650	V
Gate-to-Source Voltage	Gate-to-Source Voltage			-8/+22	V
	Recommended Operation Values of Gate-to-Source Voltage		$V_{GSop}$	-5/+18	V
Continuous Drain Current (Note 1)	Steady T <sub>C</sub> = 25°C		I <sub>D</sub>	99	Α
Power Dissipation (Note 1)			P <sub>D</sub>	348	W
Continuous Drain Current (Note 1)	Steady State	T <sub>C</sub> = 100°C	I <sub>D</sub>	70	Α
Power Dissipation (Note 1)			P <sub>D</sub>	174	W
Pulsed Drain Current (Note 2)	T <sub>C</sub> = 25°C		I <sub>DM</sub>	323	Α
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Source Current (Body Diode)			IS	75	Α
Single Pulse Drain-to-Source Avalanche Energy (I <sub>L(pk)</sub> = 11.2 A, L = 1 mH) (Note 3)			E <sub>AS</sub>	62	mJ
Maximum Lead Temperature for Soldering (1/8" from case for 5 s)			TL	260	°C

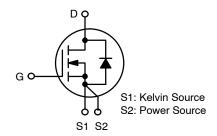
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

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- 2. Repetitive rating, limited by max junction temperature.
- 3. EAS of 62 mJ is based on starting  $T_J = 25^{\circ}C$ ; L = 1 mH,  $I_{AS} = 11.2$  A,  $V_{DD} = 50 \text{ V}, V_{GS} = 18 \text{ V}.$

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
650 V	28.5 mΩ @ 18 V	99 A



**N-CHANNEL MOSFET** 



CASE 340CJ

#### **MARKING DIAGRAM**



H4L025065SC1 = Specific Device Code

= Assembly Location

Υ = Year

WW = Work Week

= Lot Traceability

## **ORDERING INFORMATION**

Device	Package	Shipping		
NVH4L025N065SC1	TO247-4L	30 Units / Tube		

## THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Case - Steady State (Note 1)	$R_{ heta JC}$	0.43	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	40	

## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS						ı	
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$		650	-	_	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>	I <sub>D</sub> = 20 mA, referen	I <sub>D</sub> = 20 mA, referenced to 25°C		0.15	-	V/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V,	T <sub>J</sub> = 25°C	_	-	10	μΑ
		V <sub>DS</sub> = 650 V	T <sub>J</sub> = 175°C	-	-	1	mA
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{GS} = +18/-5 \text{ V}, \text{ V}$	V <sub>DS</sub> = 0 V	-	-	250	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D =$	15.5 mA	1.8	2.8	4.3	V
Recommended Gate Voltage	$V_{GOP}$			-5	-	+18	V
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 15 V, I <sub>D</sub> = 45 A	A, T <sub>J</sub> = 25°C	-	25	-	mΩ
		V <sub>GS</sub> = 18 V, I <sub>D</sub> = 45 A	A, T <sub>J</sub> = 25°C	-	19	28.5	
		V <sub>GS</sub> = 18 V, I <sub>D</sub> = 45 A	A, T <sub>J</sub> = 175°C	-	24	-	
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 45 A		-	27	-	S
CHARGES, CAPACITANCES & GATE RESISTANCE							
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 325 V		-	3480	-	pF
Output Capacitance	C <sub>OSS</sub>			-	278	-	
Reverse Transfer Capacitance	C <sub>RSS</sub>			-	25	-	
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS} = -5/18 \text{ V}, V_{DS} = 520 \text{ V},$		-	164	-	nC
Gate-to-Source Charge	$Q_{GS}$	I <sub>D</sub> = 45 A	1	-	48	_	
Gate-to-Drain Charge	$Q_{GD}$			-	48	_	
Gate-Resistance	$R_{G}$	f = 1 MHz		-	1.5	_	Ω
SWITCHING CHARACTERISTICS						•	
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS} = -5/18$		-	17	_	ns
Rise Time	t <sub>r</sub>	V <sub>DS</sub> = 400 I <sub>D</sub> = 45 A		-	19	-	
Turn-Off Delay Time	t <sub>d(OFF)</sub>	R <sub>G</sub> = 2.2 inductive lo		-	32	-	
Fall Time	t <sub>f</sub>	. Industrie	· uu	-	8	_	
Turn-On Switching Loss	E <sub>ON</sub>	1		-	93	_	μJ
Turn-Off Switching Loss	E <sub>OFF</sub>	1		-	84	_	
Total Switching Loss	E <sub>tot</sub>	1		-	177	-	
DRAIN-SOURCE DIODE CHARACTERIST		•			•		
Continuous Drain-Source Diode Forward Current	I <sub>SD</sub>	V <sub>GS</sub> = -5 V, T <sub>J</sub>	= 25°C	-	-	75	А
Pulsed Drain-Source Diode Forward Current (Note 2)	I <sub>SDM</sub>			-	-	323	
Forward Diode Voltage	$V_{SD}$	V <sub>GS</sub> = -5 V, I <sub>SD</sub> = 45 A, T <sub>J</sub> = 25°C		-	4.7	_	V
	-	•			•		

## **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified) (continued)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
DRAIN-SOURCE DIODE CHARACTERISTICS							
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS} = -5/18 \text{ V}, I_{SD} = 45 \text{ A},$ $dI_S/dt = 1000 \text{ A}/\mu\text{s}$	-	25	-	ns	
Reverse Recovery Charge	Q <sub>RR</sub>	αι <sub>S</sub> /ατ = 1000 Α/μs	-	171	-	nC	
Reverse Recovery Energy	E <sub>REC</sub>		_	15.8	-	μJ	
Peak Reverse Recovery Current	I <sub>RRM</sub>		-	13.7	-	Α	
Charge time	Ta		_	14.9	-	ns	
Discharge time	Tb		-	10.6	-	ns	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **TYPICAL CHARACTERISTICS**

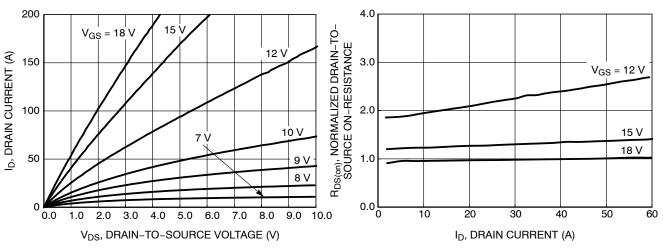


Figure 1. On-Region Characteristics

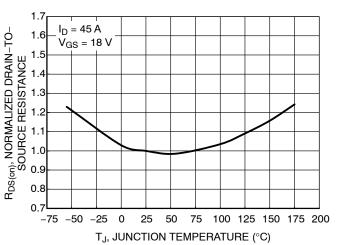


Figure 3. On–Resistance Variation with Temperature

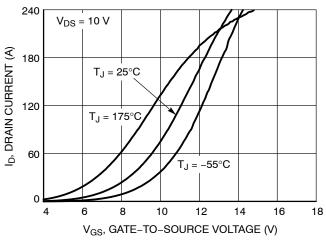


Figure 5. Transfer Characteristics

Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

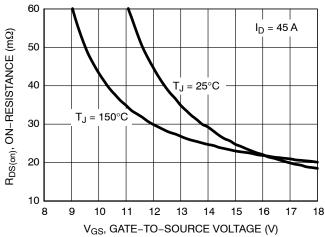


Figure 4. On-Resistance vs. Gate-to-Source Voltage

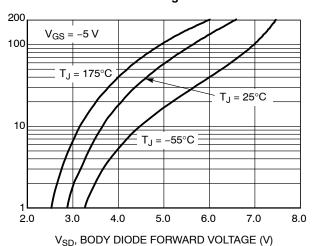
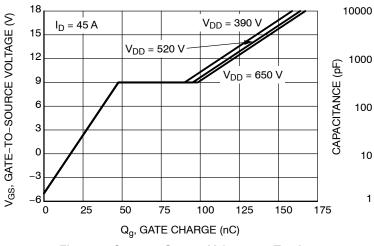


Figure 6. Diode Forward Voltage vs. Current

IS, REVERSE DRAIN CURRENT (A)

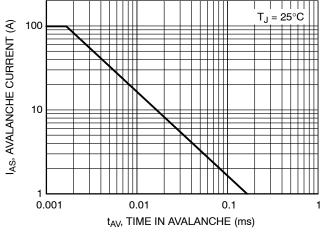
#### **TYPICAL CHARACTERISTICS**



1000 C<sub>iss</sub>
1000 C<sub>oss</sub>
100 C<sub>rss</sub>
100 C<sub>rs</sub>

Figure 7. Gate-to-Source Voltage vs. Total Charge

Figure 8. Capacitance vs. Drain-to-Source Voltage



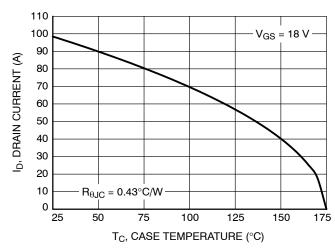
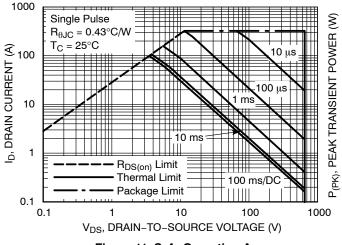


Figure 9. Unclamped Inductive Switching Capability

Figure 10. Maximum Continuous Drain Current vs. Case Temperature



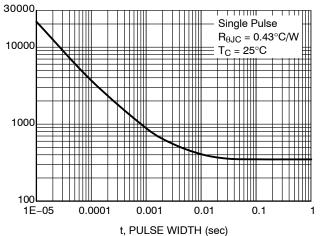


Figure 11. Safe Operating Area

Figure 12. Single Pulse Maximum Power Dissipation

## **TYPICAL CHARACTERISTICS**

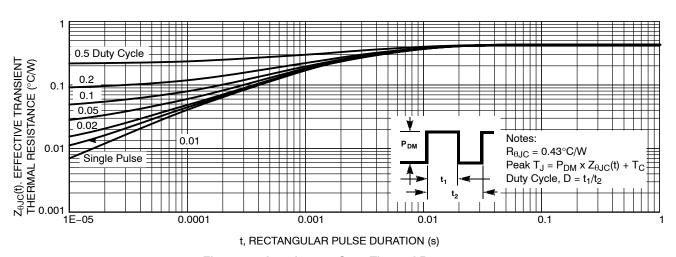
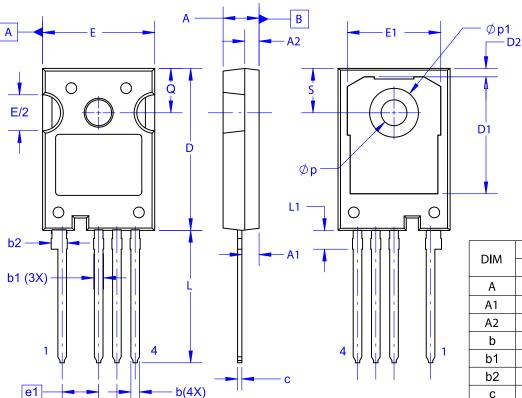


Figure 13. Junction-to-Case Thermal Response

#### TO-247-4LD CASE 340CJ **ISSUE A**

**DATE 16 SEP 2019** 



#### NOTES:

e 2X-0.254 M

- A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
  B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD
  FLASH, AND TIE BAR EXTRUSIONS.
  C. ALL DIMENSIONS ARE IN MILLIMETERS.
  D. DRAWING CONFORMS TO ASME Y14.5-2009.

DIM	MIN	NOM	MAX		
Α	4.80	5.00	5.20		
A1	2.10	2.40	2.70		
A2	1.80	2.00	2.20		
b	1.07	1.20	1.33		
b1	1.20	1.40	1.60		
b2	2.02	2.22	2.42		
С	0.50	0.60	0.70		
D	22.34	22.54	22.74		
D1	16.00	16.25	16.50		
D2	0.97	1.17	1.37		
е	2.54 BSC				
e1	5.08 BSC				
E	15.40	15.60	15.80		
E1	12.80	13.00	13.20		
E/2	4.80	5.00	5.20		
L	18.22	18.42	18.62		
L1	2.42	2.62	2.82		
р	3.40	3.60	3.80		
p1	6.60	6.80	7.00		
Q	5.97	6.17	6.37		
S	5.97	6.17	6.37		

**MILLIMETERS** 

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C3M0045065K E3M0120090J C3M0065090J-TR C3M0120100J C3M0075120J DMWS120H100SM4 DMWSH120H28SM4
DMWSH120H90SM4 DMWSH120H90SM4Q DMWSH120H28SM4Q DMWSH120H90SCT7Q DMWSH120H28SM3
DMWSH120H43SM3 DMWSH120H90SM3 DMWSH120H28SM3Q DMWSH120H90SM3Q DIF120SIC053-AQ DIW120SIC059-AQ
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G3R20MT12K G3R20MT12N G3R20MT17K G3R20MT17N G3R30MT12J-TR G3R30MT12K G3R350MT12D G3R40MT12D
G3R40MT12J